



Material Content Data Sheet



Sales Product Name		IPS80R2K4P7		Issued		25. January 2018		
MA#		MA001662852						
Package		PG-TO251-3-344		Weight*		333.85 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.008	0.30	0.30	3018	3018
leadframe	inorganic material	phosphorus	7723-14-0	0.046	0.01		139	
	non noble metal	iron	7439-89-6	0.154	0.05		462	
	non noble metal	copper	7440-50-8	154.154	46.18	46.24	461747	462348
	non noble metal	aluminium	7429-90-5	0.143	0.04	0.04	429	429
wire	non noble metal	aluminium	7429-90-5	0.143	0.04	0.04	429	429
encapsulation	organic material	carbon black	1333-86-4	0.448	0.13		1341	
	plastics	epoxy resin	-	13.584	4.07		40689	
	inorganic material	silicondioxide	60676-86-0	135.243	40.51	44.71	405104	447134
leadfinish	non noble metal	tin	7440-31-5	4.142	1.24	1.24	12407	12407
plating	non noble metal	nickel	7440-02-0	0.607	0.18	0.18	1817	1817
solder	non noble metal	tin	7440-31-5	0.028	0.01		85	
	noble metal	silver	7440-22-4	0.036	0.01		107	
	non noble metal	lead	7439-92-1	1.359	0.41	0.43	4070	4262
heatspreader	inorganic material	phosphorus	7723-14-0	0.007	0.00		21	
	non noble metal	iron	7439-89-6	0.023	0.01		69	
	non noble metal	copper	7440-50-8	22.867	6.85	6.86	68495	68585
*deviation	< 10%		Sum in total:			100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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